

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
SanDisk Corporation	04/04/2011
RECEIVING PARTY DATA	
Name:	SanDisk Technologies Inc.
Street Address:	6900 North Dallas Parkway
Internal Address:	Two Legacy Town Center
City:	Plano
State/Country:	TEXAS
Postal Code:	75024
PROPERTY NUMBERS Total: 1	
Property Type	Number
Patent Number:	7416956
CORRESPONDENCE DATA	
Fax Number:	(408)801-8512
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
Phone:	4088012863
Email:	simona.benjamin@sandisk.com
Correspondent Name:	SanDisk Corporation
Address Line 1:	601 Mccarthy Boulevard
Address Line 2:	Patent Department/Simona Benjamin
Address Line 4:	Milpitas, CALIFORNIA 95035
ATTORNEY DOCKET NUMBER:	SDK0701.000US
NAME OF SUBMITTER:	Simona Benjamin
Total Attachments: 5 source=Assignment 69#page1.tif source=Assignment 69#page2.tif source=Assignment 69#page3.tif source=Assignment 69#page4.tif source=Assignment 69#page5.tif	

CH \$40.00 7416956

ASSIGNMENT

WHEREAS, SanDisk Corporation, a Delaware corporation, doing business at 601 McCarthy Boulevard, Milpitas, CA 95035 (hereinafter referred to as **ASSIGNOR**), holds right, title and interest throughout the world in and to the patents and patent applications set forth in the attached Exhibit A, together with all divisions, continuations, or continuations-in-part thereof, and all patents issuing thereon including reissues, renewals, substitutions, re-examinations and extensions thereof, and any and all corresponding foreign patents and patent applications (hereinafter referred to as, collectively, **THE ASSIGNED PATENT RIGHTS**);

WHEREAS, SanDisk Technologies Inc., a Texas corporation, doing business at Two Legacy Town Center, 6900 North Dallas Parkway, Plano, Texas 75024, (hereinafter referred to as **ASSIGNEE**), is desirous of acquiring the full and exclusive right, title and interest in **THE ASSIGNED PATENT RIGHTS**;

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, **ASSIGNOR** hereby assigns, transfers and conveys unto the said **ASSIGNEE**, and **ASSIGNEE** accepts, all of **ASSIGNOR**'s right, title and interest throughout the world in and to **THE ASSIGNED PATENT RIGHTS** and to all Letters Patent or applications or similar legal protection, not only in the United States and its territorial possessions, but in all countries foreign thereto to be obtained for **THE ASSIGNED PATENT RIGHTS**, and to any continuation, division, renewal, substitute or reissue thereof or any legal equivalent thereof in the United States or a foreign country for the full term or terms for which the same may be granted, including all priority rights under the International Convention; and **ASSIGNOR** hereby authorizes and requests the United States Commissioner of Patents and Trademarks and any officials of foreign countries whose duty it is to issue patents on applications as aforesaid, to issue all patents for **THE ASSIGNED PATENT RIGHTS** to **ASSIGNEE** in accordance with the terms of this **ASSIGNMENT** but subject to reserved rights including but not limited to those previously retained by, granted to, or owned by, the United States government, educational institutions or both and hereby transfers and conveys all rights of action, power and benefit belonging to or accruing from **THE ASSIGNED PATENT RIGHTS** including the right to undertake proceedings to recover past and future damages and claim all other relief in respect of any acts of infringement thereof whether such acts shall have been committed before or after the date of this assignment.

No other rights, immunities, or licenses, including, without limitation, any rights to any intellectual property owned, controlled or licensable by **ASSIGNOR** are granted or assigned to **ASSIGNEE** under this **ASSIGNMENT**, either expressly or by implication, estoppel, or otherwise, other than the rights expressly recited herein.

ASSIGNOR hereby covenants that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would knowingly conflict with this Agreement;

ASSIGNOR further covenants that **ASSIGNEE** will, upon its lawful request, reasonably be provided with all pertinent facts and documents relating to **THE ASSIGNED PATENT RIGHTS** and legal equivalents as may be known and reasonably accessible to **ASSIGNOR** and that **ASSIGNOR** will testify as to the same in any administrative contest or litigation related thereto and will promptly execute and deliver to **ASSIGNEE** or its legal representative any and all papers, instruments or affidavits required to apply for, obtain, maintain, issue and enforce **THE ASSIGNED PATENT RIGHTS** and said equivalents in the United States or in any foreign country, which may be necessary or desirable to carry out the purposes thereof.

IN TESTIMONY WHEREOF, I hereunto set my hand as of the date indicated below.

SANDISK CORPORATION

Dated: 4th April 2011

Judy Bruner
Name: Judy Bruner
Title: EVP 2nd CFO

STATE OF California)
COUNTY OF Santa Clara) ss.

On this 4th day of April, 2011, before me Averil Branwen Watan (Notary Public), the undersigned Notary Public, personally appeared Judy Bruner,

who proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

I certify under PENALTY OF PERJURY under the laws of the State of California that the foregoing paragraph is true and correct.

WITNESS my hand and official seal.



Signature: Averil Watan
Signature of Notary Public

We accept the Assignment

SANDISK TECHNOLOGIES INC.

Dated: 4/4/11

James F. Brelsford
Name: James F. Brelsford
Title: President and Secretary

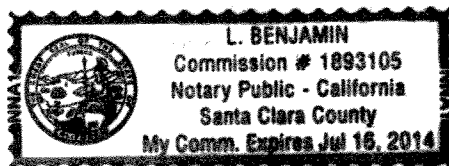
STATE OF California)
COUNTY OF Santa Clara) ss.

On this 4 day of April, 2011, before me L. Benjamin, the undersigned Notary Public, personally appeared JAMES F. BRELSFORD

who proved to me on the basis of satisfactory evidence to be the person(s) whose name(s) is/are subscribed to the within instrument and acknowledged to me that he/she/they executed the same in his/her/their authorized capacity(ies), and that by his/her/their signature(s) on the instrument the person(s), or the entity upon behalf of which the person(s) acted, executed the instrument.

I certify under PENALTY OF PERJURY under the laws of the State of California that the foregoing paragraph is true and correct.

WITNESS my hand and official seal.



Signature: L. Benjamin
Signature of Notary Public

Exhibit A

FILE #	INVENTORS	TITLE	COUNTRY	STATUS	SER #	FILING DATE	PAT #	ISSUE DATE
SDK0698.000US	Yosi Pinto, Geoffrey S Gongwer, Oren Honen	Methods for Writing Non-Volatile Memories for Increased Endurance	US	Issued	11321217	28-Dec-05	7245556	17-Jul-07
SDK0699.000US	Chin-Tien Hope Chiu, Jack Chang Chien, Meng-Ju Tsai, Cheeman Yu, Hem Takiar	SEMICONDUCTOR DIE PACKAGE INCLUDING CONSTRUCTION FOR PREVENTING DELAMINATION AND/OR CRACKING OF THE SEMICONDUCTOR DIE	US	Pending	11265336	2-Nov-05		
SDK0700.001US	Bahman Qawami, Fabrice Jogand-Coulomb, Farshid Sabet-Sharghi, Michael Holtzman, Pascal Caillon, Pedro Vargas, Po Yuan, Robert C Chang, Patricia Dwyer, Paul McAvoy	Method for Secure Storage and Delivery of Media Content	US	Pending	11322812	30-Dec-05		
SDK0700.003US	Fabrice Jogand-Coulomb, Michael Holtzman	Method for Secure Storage and Delivery of Media Content	US	Published	12696985	29-Jan-10		
SDK0700.004US	Fabrice Jogand-Coulomb, Michael Holtzman, Paul McAvoy, Po Yuan, Robert C Chang	Method for Secure Storage and Delivery of Media Content	US	Published	12697001	29-Jan-10		
SDK0700.005US	Fabrice Jogand-Coulomb, Michael Holtzman, Paul McAvoy, Po Yuan, Robert C Chang	Method for Secure Storage and Delivery of Media Content	US	Published	12697034	29-Jan-10		
SDK0700.006US	Bahman Qawami, Fabrice Jogand-Coulomb, Farshid Sabet-Sharghi, Michael Holtzman, Pascal Caillon, Patricia Dwyer, Paul McAvoy, Pedro Vargas, Po Yuan, Robert C Chang	Method for Secure Storage and Delivery of Media Content	US	Published	12697055	29-Jan-10		
SDK0700.007US	Fabrice Jogand-Coulomb, Paul McAvoy, Po Yuan, Robert C Chang	Method for Secure Storage and Delivery of Media Content	US	Published	12697078	29-Jan-10		
SDK0701.000US	Jack H. Yuan	SELF ALIGNED TRENCH FILING FOR NARROW GAP ISOLATION REGIONS	US	Issued	11251386	14-Oct-05	7416956	26-Aug-08
SDK0701.001US	Jack H. Yuan	MEMORY WITH SELF ALIGNED TRENCHES FOR NARROW GAP ISOLATION REGIONS	US	Issued	11251400	14-Oct-05	7402886	22-Jul-08
SDK0704.000US	Paul McAvoy	Portable Multi-Platform Booting	US	Pending	11618870	31-Dec-06		
SDK0704.001US	Paul McAvoy	Multi-Platform Portable Platform Systems and Architecture	US	Allowed	11618872	31-Dec-06		
SDK0705.000US	Sergey Anatolievich Gorobets, Peter John Smith, Alan Bennett	Non-Volatile Memory and Method With Multi-Stream Update Tracking	US	Issued	11192220	27-Jul-05	7366826	29-Apr-08
SDK0705.001US	Sergey Anatolievich Gorobets, Peter John Smith, Alan Bennett	Non-Volatile Memory and Method With Improved Indexing for Scratch Pad and Update Blocks	US	Issued	11192386	27-Jul-05	7386655	10-Jun-08
SDK0705.002US	Peter John Smith, Sergey Anatolievich Gorobets, Alan Bennett	Non-Volatile Memory and Method With Multi-Stream Updating	US	Issued	11191686	27-Jul-05	7412560	12-Aug-08
SDK0705.003US	Peter John Smith, Sergey Anatolievich Gorobets, Alan Bennett	Non-Volatile Memory and Method With Multi-Stream Updating	US	Published	12189396	11-Aug-08		
SDK0706.000US	Sergey Anatolievich Gorobets	Interfacing Systems Operating Through a Logical Address Space and on a Direct Data File Basis	US	Issued	11196869	3-Aug-05	7480766	20-Jan-09
SDK0707.000US	Vincent (Ming Hsun) Lee, Chih Chin Liao, Cheeman Yu, Hem Takiar	DIE PACKAGE WITH ASYMMETRIC LEADFRAME CONNECTION	US	Issued	11170897	30-Jun-05	7375415	20-May-08
SDK0707.001US	Vincent (Ming Hsun) Lee, Chih Chin Liao, Cheeman Yu, Hem Takiar	DIE PACKAGE WITH ASYMMETRIC LEADFRAME CONNECTION	US	Published	12060418	1-Apr-08		